

# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol    | Parameter                                     | Value |            |        | Unit             |
|-----------|-----------------------------------------------|-------|------------|--------|------------------|
|           |                                               | NPN   | BDX53B     | BDX53C |                  |
|           |                                               | PNP   | BDX54B     | BDX54C |                  |
| $V_{CBO}$ | Collector-base voltage ( $I_E = 0$ )          |       | 80         | 100    | V                |
| $V_{CEO}$ | Collector-emitter voltage ( $I_B = 0$ )       |       | 80         | 100    | V                |
| $V_{EBO}$ | Emitter-base voltage ( $I_C = 0$ )            |       | 5          |        | V                |
| $I_C$     | Collector current                             |       | 8          |        | A                |
| $I_{CM}$  | Collector peak current (repetitive)           |       | 12         |        | A                |
| $I_B$     | Base current                                  |       | 0.2        |        | mA               |
| $P_{TOT}$ | Total dissipation at $T_C = 25^\circ\text{C}$ |       | 60         |        | W                |
| $T_{stg}$ | Storage temperature                           |       | -65 to 150 |        | $^\circ\text{C}$ |
| $T_J$     | Max. operating junction temperature           |       | 150        |        | $^\circ\text{C}$ |

*Note:* For PNP types voltage and current values are negative.

## 2 Electrical characteristics

( $T_{CASE}=25^{\circ}\text{C}$  unless otherwise specified)

**Table 3. Electrical characteristics**

| Symbol              | Parameter                                          | Test conditions                                                     | Min.      | Typ. | Max. | Unit   |
|---------------------|----------------------------------------------------|---------------------------------------------------------------------|-----------|------|------|--------|
| $V_{CE(sus)}^{(1)}$ | Collector-emitter sustaining voltage ( $I_B = 0$ ) | $I_C = 100\text{ mA}$<br>for BDX53B - BDX54B<br>for BDX53C - BDX54C | 80<br>100 |      |      | V<br>V |
| $I_{CBO}$           | Collector cut-off current ( $I_E = 0$ )            | $V_{CB} = 80\text{ V}$<br>for BDX53B - BDX54B                       |           |      | 0.2  | mA     |
|                     |                                                    | $V_{CB} = 100\text{ V}$<br>for BDX53C - BDX54C                      |           |      | 0.2  | mA     |
| $I_{CEO}$           | Collector cut-off current ( $I_B = 0$ )            | $V_{CE} = 40\text{ V}$<br>for BDX53B - BDX54B                       |           |      | 0.5  | mA     |
|                     |                                                    | $V_{CE} = 50\text{ V}$<br>for BDX53C - BDX54C                       |           |      | 0.5  | mA     |
| $I_{EBO}$           | Emitter cut-off current ( $I_C = 0$ )              | $V_{EB} = 5\text{ V}$                                               |           |      | 2    | mA     |
| $V_{CE(sat)}^{(1)}$ | Collector-emitter saturation voltage               | $I_C = 3\text{ A}; I_B = 12\text{ mA}$                              |           |      | 2    | V      |
| $V_{BE(sat)}^{(1)}$ | Base-emitter saturation voltage                    | $I_C = 3\text{ A}; I_B = 12\text{ mA}$                              |           |      | 2.5  | V      |
| $h_{FE}^{(1)}$      | DC current gain                                    | $I_C = 3\text{ A}; V_{CE} = 3\text{ V}$                             | 750       |      |      |        |
| $V_F^{(1)}$         | Diode forward voltage                              | $I_F = 3\text{ A};$                                                 |           | 1.8  | 2.5  | V      |
|                     |                                                    | $I_F = 8\text{ A};$                                                 |           | 2.5  |      | V      |

1. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

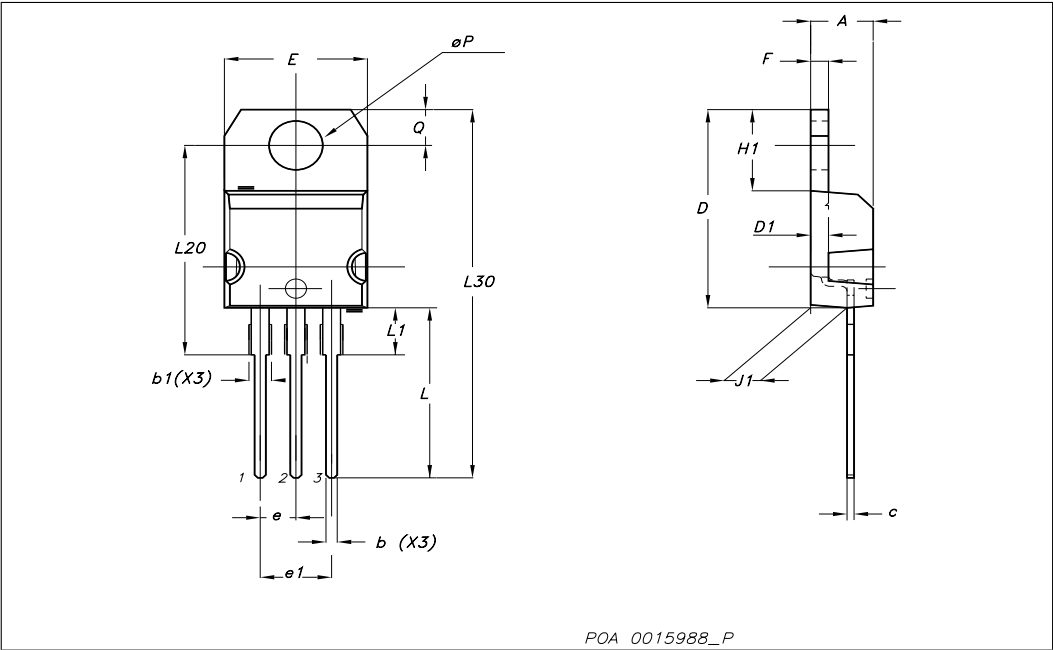
**Note:** For PNP types voltage and current values are negative.

### 3      **Package mechanical data**

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)

TO-220 mechanical data

| Dim | mm    |       |       | inch  |       |       |
|-----|-------|-------|-------|-------|-------|-------|
|     | Min   | Typ   | Max   | Min   | Typ   | Max   |
| A   | 4.40  |       | 4.60  | 0.173 |       | 0.181 |
| b   | 0.61  |       | 0.88  | 0.024 |       | 0.034 |
| b1  | 1.14  |       | 1.70  | 0.044 |       | 0.066 |
| c   | 0.49  |       | 0.70  | 0.019 |       | 0.027 |
| D   | 15.25 |       | 15.75 | 0.6   |       | 0.62  |
| D1  |       | 1.27  |       |       | 0.050 |       |
| E   | 10    |       | 10.40 | 0.393 |       | 0.409 |
| e   | 2.40  |       | 2.70  | 0.094 |       | 0.106 |
| e1  | 4.95  |       | 5.15  | 0.194 |       | 0.202 |
| F   | 1.23  |       | 1.32  | 0.048 |       | 0.051 |
| H1  | 6.20  |       | 6.60  | 0.244 |       | 0.256 |
| J1  | 2.40  |       | 2.72  | 0.094 |       | 0.107 |
| L   | 13    |       | 14    | 0.511 |       | 0.551 |
| L1  | 3.50  |       | 3.93  | 0.137 |       | 0.154 |
| L20 |       | 16.40 |       |       | 0.645 |       |
| L30 |       | 28.90 |       |       | 1.137 |       |
| ØP  | 3.75  |       | 3.85  | 0.147 |       | 0.151 |
| Q   | 2.65  |       | 2.95  | 0.104 |       | 0.116 |



## 4 Revision history

**Table 4. Document revision history**

| Date        | Revision | Changes                                                                            |
|-------------|----------|------------------------------------------------------------------------------------|
| 09-Sep-2004 | 3        |                                                                                    |
| 23-Oct-2007 | 4        | Technology change from epibase to planar (PCN APM-PWR/07/2417 and APM-PWR/07/2615) |

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